

RJ1P04BBH

Nch 100V 80A Power MOSFET

V _{DSS}	100V
R _{DS(on)} (Max.)	8.8mΩ
I _D	±80A
P _D	89W

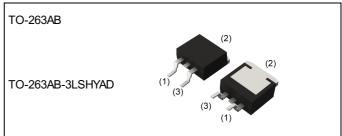
Features

- 1) Low on resistance
- 2) High power small mold package (TO263AB)
- 3) Pb-free plating ; RoHS compliant
- 4) 100% UIS tested

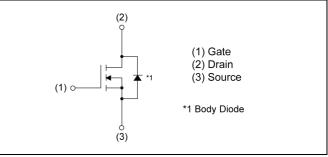
Application

Switching

Outline



Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	24
	Quantity (pcs)	800
	Taping code	TL1
	Marking	RJ1P04BBH

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Para	meter	Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	100	V	
Silicon limit (V _{GS} =10V)		۱ _D *1	±80	А	
Continuous drain current	$T_{c} = 25^{\circ}C (V_{GS} = 10V)$	۱ _D *2	±40	А	
Pulsed drain current		I _{DP} *3	±320	А	
Gate - Source voltage		V _{GSS}	±20	V	
Avalanche current, single pulse		I_{AS}^{*4}	22	А	
Avalanche energy, single pulse		E_{AS}^{*4}	39	mJ	
Power dissipation		P _D *2	89	W	
Junction temperature		Tj	150	°C	
Operating junction and storage temperature range		T _{stg}	-55 to +150	°C	

•Thermal resistance

Parameter	Symbol	Values			Linit
Falameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*2}	-	-	1.4	°C/W

•Electrical characteristics (T_a = 25°C)

Deremeter	Currence of	Symbol Conditions -		Values		
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		100	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}} I_{D} = 1mA$ referenced to 25°C		-	62.3	-	mV/°C
Zero gate voltage drain current	I_{DSS} V_{DS} = 100V, V_{GS} = 0V		-	-	5	μA
Gate - Source leakage current	I_{GSS} V_{GS} = ±20V, V_{DS} = 0V		-	-	±500	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1mA$	2.0	-	4.0	V
Gate threshold voltage temperature coefficient $\Delta V_{GS(th)}$ ΔT_j ID = 1mA referenced		I _D = 1mA referenced to 25°C	-	-4.5	-	mV/°C
Static drain - source	D *5	V _{GS} = 10V, I _D = 40A	-	6.8	8.8	
on - state resistance	R _{DS(on)} *5	V _{GS} = 6V, I _D = 20A	-	8.4	12.5	mΩ
Gate resistance	R_{G}	-	-	0.9	-	Ω
Forward Transfer Admittance	Y _{fs} * ⁵	V _{DS} = 5V, I _D = 20A	20	-	-	S

*1 Limited by silicon chip capability.

*2 T_c=25°C, Limited only by maximum temperature allowed.

*3 Pw \leq 10µs, Duty cycle \leq 1%

*4 L \simeq 0.1mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_j = 25°C Fig.3-1,3-2

*5 Pulsed





•Electrical characteristics (T_a = 25°C)

Deremeter	Symbol Conditions		Values			Linit
Parameter			Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	2410	-	
Output capacitance	C _{oss}	V _{DS} = 50V	-	460	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	20	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 50V, V_{GS}$ = 10V	-	24	-	
Rise time	t _r *5	I _D = 20A	-	22	-	
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 2.5\Omega$	-	60	-	ns
Fall time	t _f *5	R _G = 10Ω	-	30	-	

• Gate charge characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditions		Values			1 1	
Parameter	Symbol Conditions		UNS	Min.	Тур.	Max.	Unit	
Total gata abarga	○ *5		V _{GS} = 10V	-	38.0	-		
Total gate charge	Q _g *5	$V_{DD} \simeq 50V$		-	25.0	-	nC	
Gate - Source charge	Q_{gs}^{*5}	I _D = 40A	V _{GS} = 6V	-	8.5	-	nc	
Gate - Drain charge	Q _{gd} *5			-	9.8	-		

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Doromotor	Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Continuous forward current	ا _S *2		-	-	40	А
Pulse forward current	ا _{SP} *3	-	-	-	320	А
Forward voltage	V _{SD} *5	V _{GS} = 0V, I _S = 40A	-	-	1.2	V
Reverse recovery time	t _{rr} *5	I _S = 40A, V _{GS} =0V	-	63	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/µs	-	125	-	nC



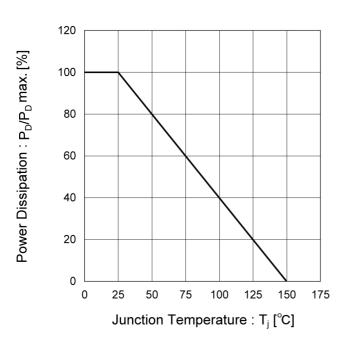


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

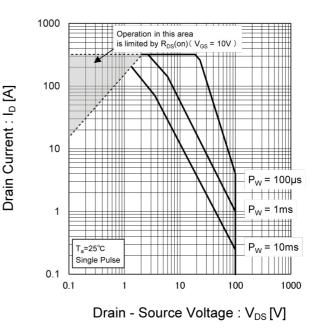
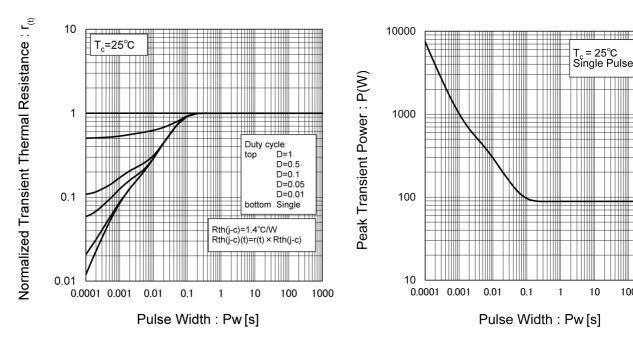


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power Dissipation



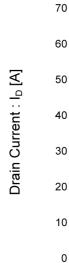


10

100

1000

Electrical characteristic curves



0

Fig.5 Typical Output Characteristics(I)

′_{GS}= 10V

V_{GS}= 8.0∀

V_{GS}= 6.0V

T_a=25°C

V_{GS}= 4.5V

V_{GŞ}= 4.0V

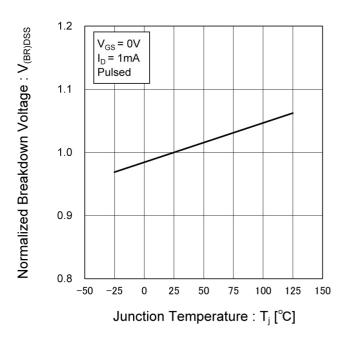
1

Pulsed

Fig.7 Normalized Breakdown Voltage vs. **Junction Temperature**

0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : V_{DS} [V]



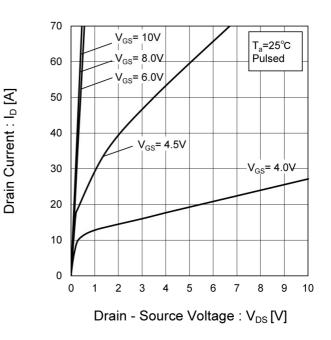
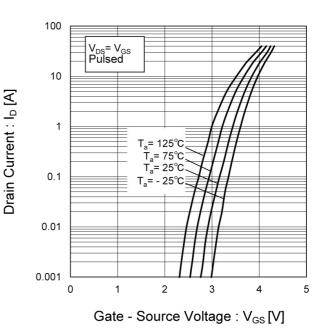


Fig.6 Typical Output Characteristics(II)

Fig.8 Typical Transfer Characteristics





• Electrical characteristic curves

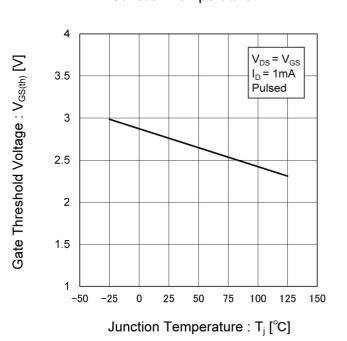


Fig.9 Gate Threshold Voltage vs. Junction Temperature

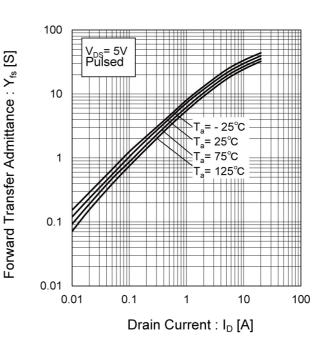
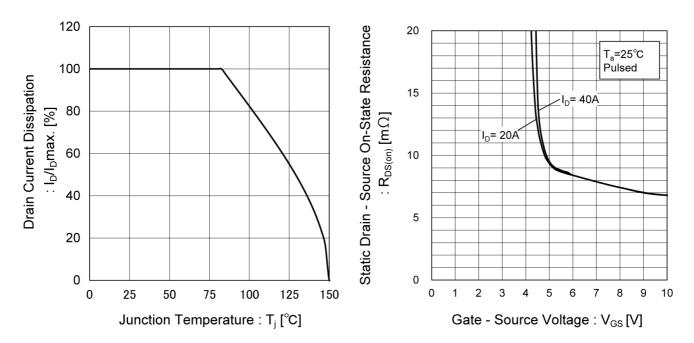


Fig.10 Forward Transfer Admittance vs. Drain Current



Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





• Electrical characteristic curves

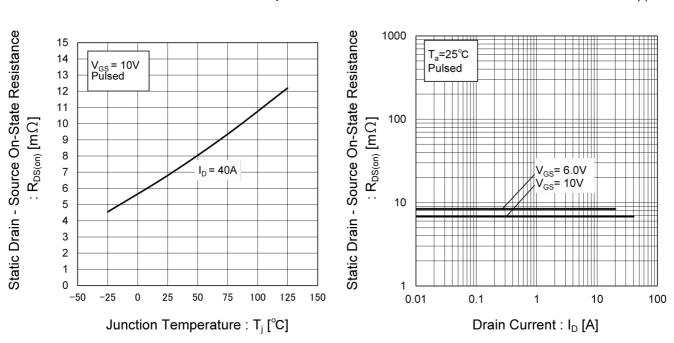
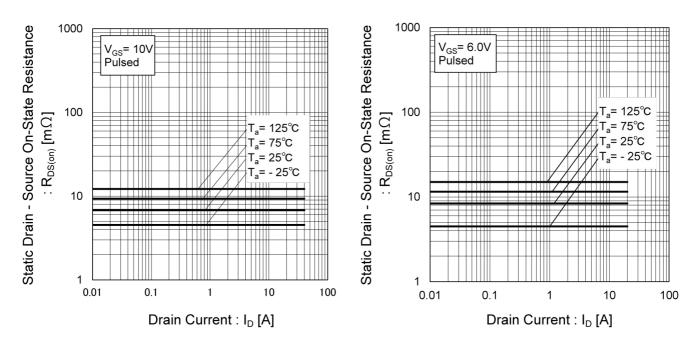


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II) Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)





• Electrical characteristic curves

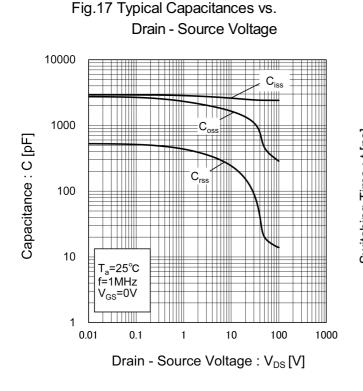


Fig.18 Switching Characteristics

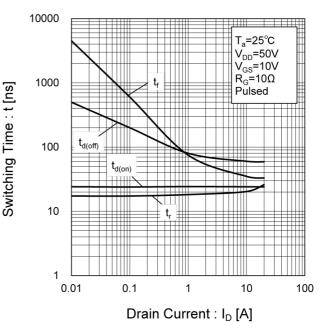


Fig.19 Typical Gate Charge

Gate - Source Voltage : V_{GS} [V]

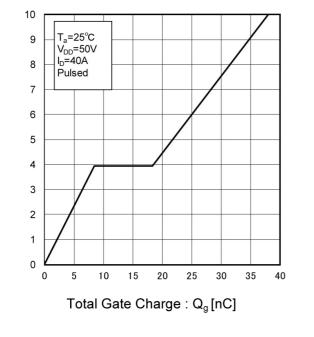
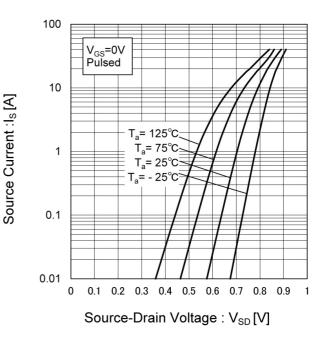


Fig.20 Source Current vs. Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

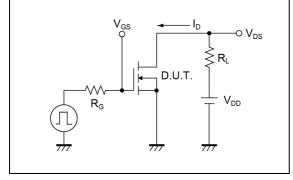


Fig.2-1 Gate Charge Measurement Circuit

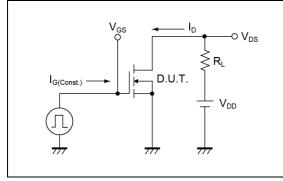


Fig.3-1 Avalanche Measurement Circuit

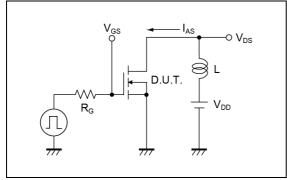


Fig.1-2 Switching Waveforms

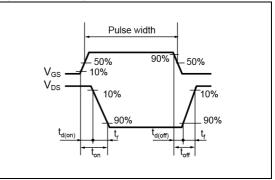


Fig.2-2 Gate Charge Waveform

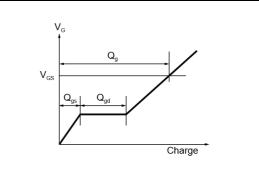
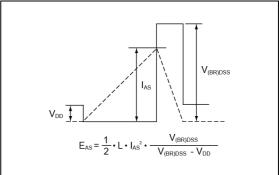
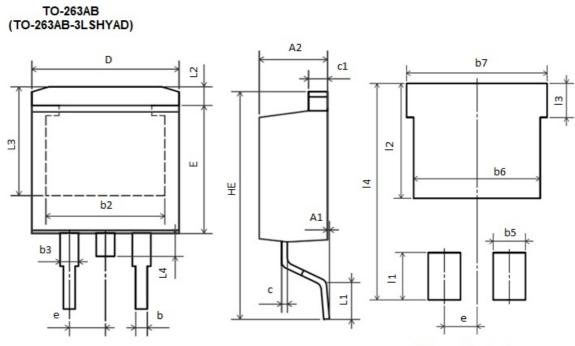


Fig.3-2 Avalanche Waveform





Dimensions



Reference land pattern

DIM	MILIME	TERS	INC	HES
DIN	MIN	MAX	MIN	MAX
A1	0.00	0.25	0.000	0.010
A2	4.37	4.77	0.168	0.188
b	0.70	0.96	0.028	0.038
b2	7.50	<u> </u>	0.295	1
b3	1.17	1.47	0.046	0.058
С	0.30	0.53	0.012	0.021
c1	1.22	1.42	0.048	0.056
D	9.86	10.36	0.388	0.408
E	8.50	8.90	0.335	0.350
е	2.5	2.54		00
HE	14.70	15.50	0.579	0.610
L1	2.00	2.60	0.079	0.102
L2	1.07	1.47	0.042	0.058
L3	6.60	1. . .	0.260	1
L4	1.40	1.70	0.055	0.067

DIM	MILIMETERS	INCHES
DIM	NOM	NOM
1	3.5	0.14
12	8.5	0.33
13	2.5	0.10
4	16.0	0.63
b5	2.5	0.10
b6	10.0	0.39
b7	11.0	0.43

Dimension in mm / inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSI	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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